

BFN27

PNP Silicon High-Voltage Transistors

- Suitable for video output stages in TV sets and switching power supplies
- High breakdown voltage
- Low collector-emitter saturation voltage
- Complementary types: BFN26 (NPN)
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101



3 2 1

Туре	Marking	Pin Configuration			Package
BFN27	FLs	1=B	2=E	3=C	SOT23

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V _{CEO}	300	V
Collector-base voltage	V _{CBO}	300	
Emitter-base voltage	V _{EBO}	5	
Collector current	I _C	200	mA
Peak collector current, $t_p \le 10 \text{ ms}$	I _{CM}	500	
Base current	I _B	100	
Peak base current	/ _{BM}	200	
Total power dissipation-	P _{tot}	360	mW
$T_{S} \leq 74 \ ^{\circ}C$			
Junction temperature	T _i	150	°C
Storage temperature	T _{stg}	-65 150	

Parameter	Symbol	Value	Unit
Junction - soldering point ¹⁾	R _{thJS}	≤ 210	K/W

¹For calculation of R_{thJA} please refer to Application Note AN077 (Thermal Resistance Calculation)



Parameter	Symbol		Values		Unit
		min.	typ.	max.	
DC Characteristics				i	
Collector-emitter breakdown voltage	V _{(BR)CEO}	300	-	-	V
<i>I</i> _C = 1 mA, <i>I</i> _B = 0					
Collector-base breakdown voltage	V _{(BR)CBO}	300	-	-	
$I_{\rm C}$ = 100 µA, $I_{\rm E}$ = 0					
Emitter-base breakdown voltage	V _{(BR)EBO}	5	-	-	
<i>I</i> _E = 100 μA, <i>I</i> _C = 0					
Collector-base cutoff current	I _{CBO}				μA
$V_{\rm CB}$ = 250 V, $I_{\rm E}$ = 0		-	-	0.1	
$V_{\rm CB}$ = 250 V, $I_{\rm E}$ = 0 , $T_{\rm A}$ = 150 °C		-	-	20	
Emitter-base cutoff current	I _{EBO}	-	-	100	nA
$V_{\rm EB}$ = 5 V, $I_{\rm C}$ = 0					
DC current gain ¹⁾	h _{FE}				-
<i>I</i> _C = 1 mA, <i>V</i> _{CE} = 10 V		25	-	-	
<i>I</i> _C = 10 mA, <i>V</i> _{CE} = 10 V		40	-	-	
<i>I</i> _C = 30 mA, <i>V</i> _{CE} = 10 V		30	-	-	
Collector-emitter saturation voltage ¹⁾	V _{CEsat}	-	-	0.5	V
<i>I</i> _C = 20 mA, <i>I</i> _B = 2 mA					
Base emitter saturation voltage ¹⁾	V _{BEsat}	-	-	0.9]
<i>I</i> _C = 20 mA, <i>I</i> _B = 2 mA					
AC Characteristics				•	•
Transition frequency	f _T	-	100	-	MHz
<i>I</i> _C = 20 MHz, <i>V</i> _{CE} = 10 V, <i>f</i> = 100 MHz					
Collector-base capacitance	C _{cb}	-	2.5	-	pF
			1	1	1

Electrical Characteristics at $T_A = 25^{\circ}C_{1}$	unless otherwise specified
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¹Pulse test: t < 300 μ s; D < 2%

 V_{CB} = 30 V, f = 1 MHz



DC current gain $h_{\text{FE}} = f(I_{\text{C}})$

*V*_{CE} = 10 V







Operating range $I_{\rm C} = f(V_{\rm CEO})$

 $T_{\rm A} = 25^{\circ}{\rm C}, D = 0$



Collector cutoff current $I_{CBO} = f(T_A)$

 $V_{\rm CBO}$ = 200 V





Transition frequency $f_{\rm T} = f(I_{\rm C})$

*V*_{CE} = 10 V



Total power dissipation $P_{tot} = f(T_S)$





Permissible Pulse Load $R_{\text{thJS}} = f(t_p)$







BFN27

Permissible Pulse Load

 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_{\text{p}})$









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